

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









## **MS2473**

### 600 Watts, 50 Volts, Pulsed Avionics 1090 MHz

#### **GENERAL DESCRIPTION**

The MS2473 is a high power COMMON BASE bipolar transistor. It is designed for pulsed systems in the 1090MHz frequency band. The device has gold thin-film metallization for proven highest MTTF. Low thermal resistance packaging reduces the junction temperature and extends device lifetime.

#### ABSOLUTE MAXIMUM RATINGS

Maximum Power Dissipation @ 25°C<sup>2</sup> 2300 Watts

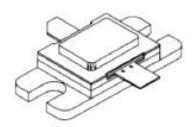
**Maximum Voltage and Current** 

BVcboCollector to Base Voltage65 VoltsBVeboEmitter to Base Voltage3.5 VoltsIcCollector Current46 Amps

**Maximum Temperatures** 

Storage Temperature  $-65 \text{ to} + 150^{\circ}\text{C}$ Operating Junction Temperature  $+200^{\circ}\text{C}$ 

# CASE OUTLINE M112



.400 x .500 2LFL (M112) hermetically sealed

## ELECTRICAL CHARACTERISTICS @ 25 °C

SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Pout Pin Pg ¶c RL <sub>IN</sub>	Power Out Power Input = 150W Power Gain Collector Efficiency Input Return Loss	F = 1090 MHz Vcc = 50 Volts PW = 10 µsec DF = 1% F = 1090 MHz	600 6.0 35 10	150		Watts Watts dB % dB

BVebo BVcbo	Emitter to Base Breakdown Collector to Base Breakdown	Ie = 10 mA Ic = 25 mA	3.5 65			Volts Volts
Ices	Collector to Emitter Leakage	Vce = 50V			35	mA
h <sub>FE</sub>	DC - Current Gain	Vce = 5V, Ic = 1A	5		200	
$\Theta jc^2$	Thermal Resistance			0.06		C/W

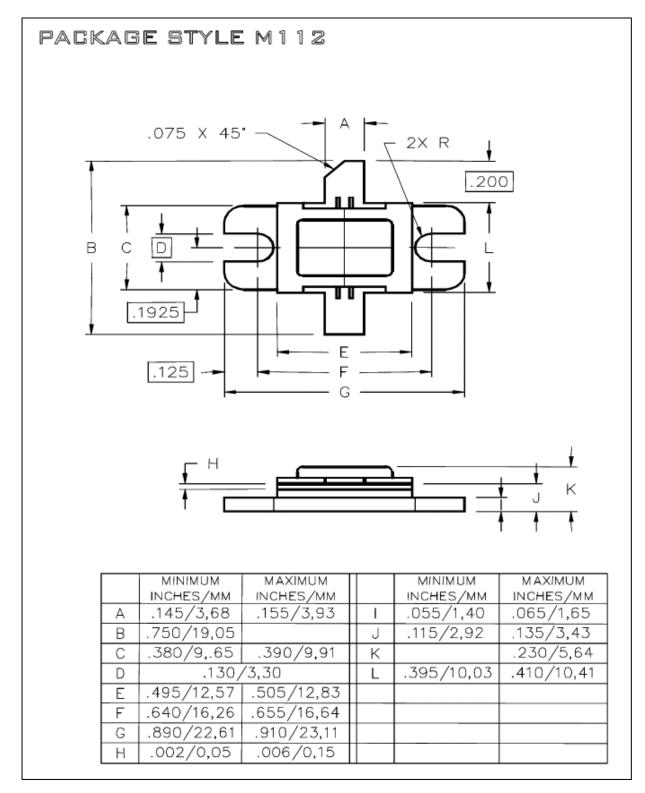
Note 1: At rated output power and pulse conditions

2: At rated pulse conditions

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